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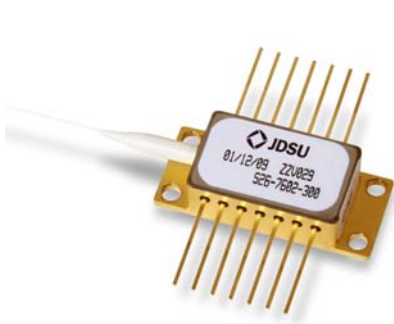
LASER LAB SOURCE
marketplace for **Scientists & Engineers**

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Up to 340 mW Fiber Bragg Grating Stabilized 980 nm Pump Modules S26 Series



Key Features

- Operating power range from 100 – 340 mW
- Reduced TEC power consumption compatible with legacy temperature control
- Low-profile, 14-PIN butterfly package
- Fiber Bragg grating stabilization
- Wavelength selection available
- Integrated thermoelectric cooler, thermistor, and monitor diode
- High dynamic range
- Excellent low power stability

Applications

- Dense wavelength division multiplexing (DWDM) EDFAs for small package designs
- High bit-rate, high channel-count EDFAs
- CATV distribution

Compliance

- Telcordia GR-468-CORE

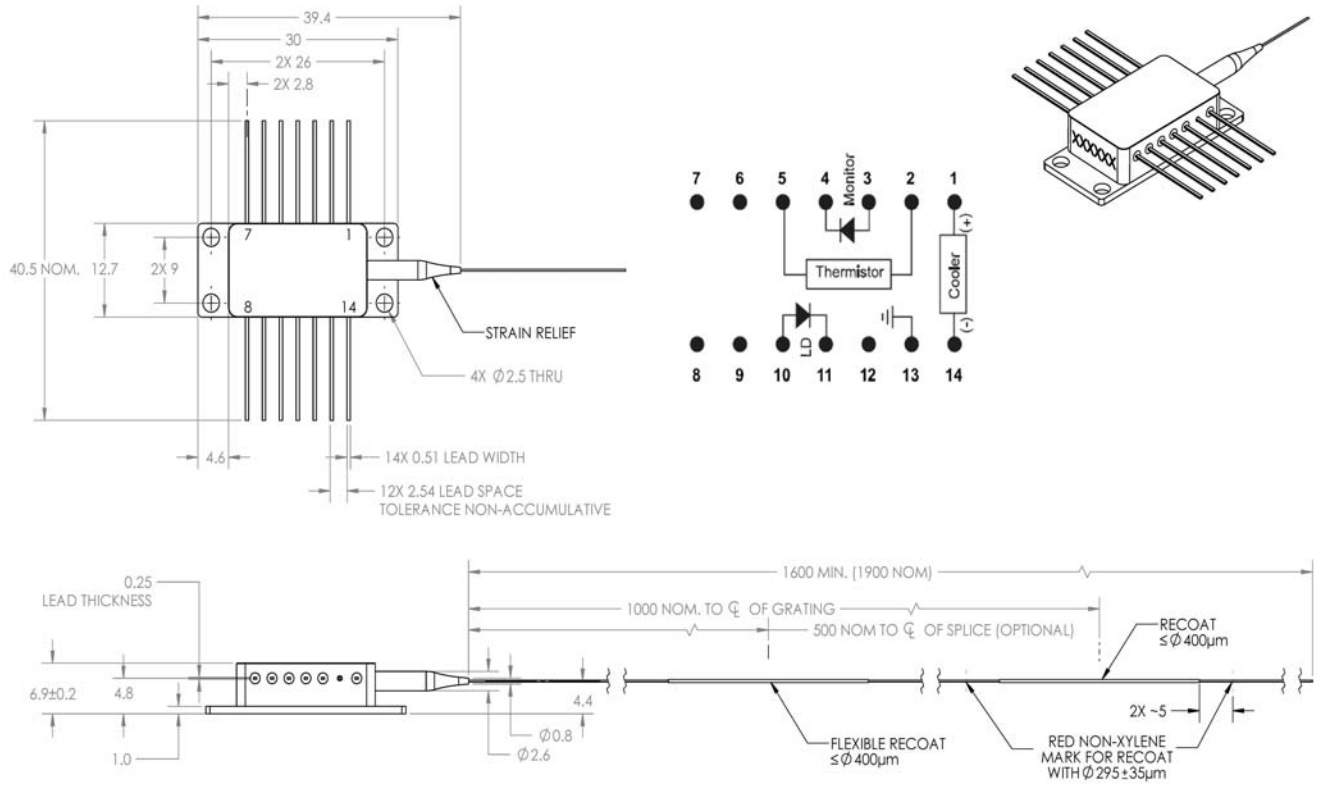
The JDSU S26 Series pump laser module uses a revolutionary design and lean manufacturing processes to significantly advance the performance and scalability of 980 nm pumps. The semicooled 45°C laser diode operation provides for a significant reduction in TEC and overall power consumption. The module meets the stringent requirements of the telecommunications industry including Telcordia GR-468-CORE for hermetic 980 nm pump modules.

The S26 Series pump module, which uses Fiber Bragg grating stabilization to lock the emission wavelength, provides a noise-free, narrowband spectrum even under changes in temperature, drive current, and optical feedback. Wavelength selection is available for applications requiring the highest performance in spectrum control with the highest power available.

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Dimensions Diagram

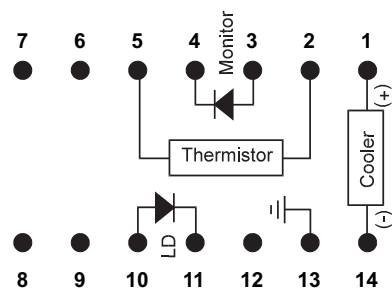
(Specifications in mm unless otherwise noted.)



Pinout

Pin Description

Pin	Description
1	Cooler (+)
2	Thermistor
3	Monitor PD anode
4	Monitor PD cathode
5	Thermistor
6	N/C
7	N/C
8	N/C
9	N/C
10	Laser anode
11	Laser cathode
12	N/C
13	Case ground
14	Cooler (-)



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Table 1: Absolute Maximum Ratings

Parameter	Symbol	Test Conditions	Minimum	Maximum
Operating case temperature	T _{op}	-	-5°C	75°C
Storage temperature	T _{stg}	2000 hours	-40°C	85°C
Laser operating temperature	T _{LD}	-	-5°C	50°C
LD reverse voltage	V _r	-	-	2 V
LD forward current	I _{f_max}	48 hours maximum	-	1000 mA
LD reverse current		-	-	10 μA
PD reverse voltage	V _{PD}	-	-	20 V
PD forward current	I _{PF}	-	-	10 mA
LD electrostatic discharge (ESD)	V _{ESD LD}	C = 100 pF, R = 1.5 kΩ, human body model	-	1000 V
	V _{ESD PD}	C = 100 pF, R = 1.5 kΩ, human body model	-	700 V
TEC current	I _{TEC}	-	-0.75 A	1.5 A
TEC voltage	V _{TEC}	-	-	2.5 V
Axial pull force		3 x 10 seconds	-	5 N
Side pull force		3 x 10 seconds	-	2.5 N
Fiber bend radius		-	16 mm	-
Relative humidity	RH	Non-condensing	5%	95%
Lead soldering time		300°C	-	10 seconds

Note: Absolute maximum ratings are the maximum stresses that may be applied to the module for short periods of time without causing damage. Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Exposure to absolute maximum ratings for extended periods of time or exposure to more than one absolute maximum rating simultaneously may adversely affect device reliability. Specifications may not necessarily be met under these conditions.

Table 2: Operating Parameters(BOL, T_{case} = -5 to 75°C, -50 dB reflection, unless otherwise noted.)

Product Code	Maximum Operating Power P _{op} (mW)	Maximum Operating Current I _{op} (mA)	Minimum Kink-Free Power P _{max} (mW)	Kink-Free Current I _{max} (mA) Maximum
S26-xx02-100	100	230	110	255
S26-xx02-120	120	275	130	300
S26-xx02-140	140	320	155	355
S26-xx02-160	160	365	175	395
S26-xx02-180	180	405	200	455
S26-xx02-200	200	450	220	500
S26-xx02-220	220	495	240	540
S26-xx02-240	240	535	265	595
S26-xx02-260	260	580	285	645
S26-xx02-280	280	625	310	700
S26-xx02-300	300	670	330	740
S26-xx02-320	320	720	350	790
S26-xx02-340	340	765	375	855

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Table 3: Available Peak Wavelength Selection

Product Code	Minimum Center Wavelength	Maximum Center Wavelength
S26-7402-xxx	973.5 nm	975.0 nm
S26-7602-xxx	975.0 nm	977.0 nm

Table 4: Electro-optical Performance(BOL, $T_{case} = -5$ to $75^{\circ}C$, $P_f = 20$ mW to P_{max} , -50 dB reflection, unless otherwise noted.)

Parameter	Symbol	Test Condition	Minimum	Maximum
Threshold current	I_{th-BOL}		-	35 mA
Forward voltage	V_f	$I_f = I_{op}$	-	2.5 V
Fiber output power range	P_f		20 mW	P_{op}
Pump power in band	P_{pump}	$P_{pump} Band = \lambda_c \pm 1.5$ nm, at P_{op}	90%	-
Spectral width	$\Delta\lambda_{RMS}$	50 mW < $P < P_{op}$	-	2.0 nm
Wavelength tuning vs. temperature	$\Delta\lambda/T$	$I_f = I_{op}$	-	0.01 nm/ $^{\circ}C$
Optical power stability	$\Delta P_{f,t}$	Over P_f range, DC to -50 kHz	-	-
		5 mW < $P_{op} < 12$ mW	-	10%
		12 mW < $P_{op} < 20$ mW	-	2.0%
		20 mW to P_{op}	-	1.0%
Tracking ratio	TE	$0.1P_{op} < P_f < P_{op}$	0.75	1.25
Tracking error	TR	At P_{op}	-25%	25%
Monitor diode responsivity	I_{BF}	At P_{op}	1 $\mu A/mW$	5 $\mu A/mW$
Thermistor resistance	R_{th}	$T_{set} = 45^{\circ}C$	9.5 k Ω	10.5 k Ω
		$T_{set} = 25^{\circ}C$	21.7 k Ω	24.0 k Ω

- The tracking error is defined as the normalized change of output power relative to the operating power over case temperature range ($0^{\circ}C$ to $75^{\circ}C$), at constant back-face monitor current corresponding to the operating power at $45^{\circ}C$.
- The tracking ratio is a measure of the front-to-back tracking when the output power is varied. On a plot of optical power versus back-face photocurrent, a straight line is drawn between the minimum power (20 mW) and the operating power (P_{op}) points. The tracking ratio is defined as the ratio between measured optical power (shown as data points on the plot) to the value derived from the straight line.

Table 5: TEC and Total Module Power Consumption(BOL for $\Delta T = 30^{\circ}C$, $T_{case} = 75^{\circ}C$, $T_{LD} = 45^{\circ}C$)

Product Code	TEC Current I_{max} (A)	TEC Voltage V_{max} (V)	TEC Power Consumption P_{TEC} (W)	Total Module Power Consumption P_{max} (W)
S26-xx02-100	0.55	1.01	0.50	0.81
S26-xx02-120	0.58	1.03	0.55	0.93
S26-xx02-140	0.61	1.05	0.59	1.04
S26-xx02-160	0.63	1.08	0.63	1.15
S26-xx02-180	0.65	1.10	0.67	1.27
S26-xx02-200	0.68	1.12	0.70	1.39
S26-xx02-220	0.71	1.15	0.75	1.52
S26-xx02-240	0.74	1.18	0.80	1.66
S26-xx02-260	0.77	1.22	0.86	1.82
S26-xx02-280	0.81	1.26	0.94	2.00
S26-xx02-300	0.86	1.30	1.03	2.21
S26-xx02-320	0.92	1.35	1.15	2.44
S26-xx02-340	0.98	1.41	1.30	2.71

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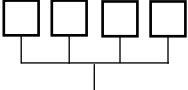
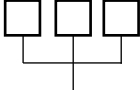
Table 6: HI 1060 Fiber Nominal Characteristics and Tolerances

Parameters	Specification
Cutoff wavelength	920 nm
Maximum attenuation at 980 nm	2.1 dB/km
Cladding outside diameter	125 \pm 1 μ m
Coating outside diameter	245 \pm 10 μ m
Core-cladding concentricity	\leq 0.5 μ m
Mode field diameter	5.9 \pm 0.3 μ m

Ordering Information

For more information on this or other products and their availability, please contact your local JDSU account manager or JDSU directly at 1-800-498-JDSU (5378) in North America and +800-5378-JDSU worldwide or via e-mail at customer.service@jdsu.com.

Sample: S26-7402-180

S26- 		- 	
Code	Peak Wavelength	Code	Maximum Operating Power
7402	973.5 to 975.0 nm	100	100 mW
7602	975.0 to 977.0 nm	120	120 mW
		140	140 mW
		160	160 mW
		180	180 mW
		200	200 mW
		220	220 mW
		240	240 mW
		260	260 mW
		280	280 mW
		300	300 mW
		320	320 mW
		340	340 mW

User Safety
Safety and Operating Considerations

The laser light emitted from this laser diode is invisible and may be harmful to the human eye. Avoid looking directly into the fiber when the device is in operation.

CAUTION: THE USE OF OPTICAL INSTRUMENTS WITH THIS PRODUCT INCREASES EYE HAZARD.

Operating the laser diode outside of its maximum ratings may cause device failure or a safety hazard. Power supplies used with this component cannot exceed maximum peak optical power.

CW laser diodes may be damaged by excessive drive current or switching transients. When using power supplies, the laser diode should be connected with the main power on and the output voltage at zero. The current should be increased slowly while monitoring the laser diode output power and the drive current. Careful attention to heatsinking and proper mounting of this device is required to ensure specified performance over its operating life. To maximize thermal transfer to the heatsink, the heatsink mounting surface must be flat to within .001" and the mounting screws must be torqued down to 1.5 in.-lb.

ESD PROTECTION—Electrostatic discharge (ESD) is the primary cause of unexpected laser diode failure. Take extreme precaution to prevent ESD. Use wrist straps, grounded work surfaces, and rigorous antistatic techniques when handling laser diodes.

Labeling
21 CFR 1040.10 Compliance

Because of the small size of these devices, the output power and laser emission indicator label shown below is attached to the individual shipping container. All labels are illustrated here to comply with 21 CFR 1040.10 as applicable under the Radiations Control for Health and Safety Act of 1968.

14-Pin Module Label

Shipping Box Label

Output Power and Laser Emission Indicator Label
